Thursday Afternoon, October 22, 2015

Additive Manufacturing/3D Printing Focus Topic
Room: 211A - Session AM+EM+MS+TF-ThA

Additive Fabrication for Electronic Devices and Systems
Moderator: Jim Fitz-Gerald, University of Virginia, Gregory Whiting, Palo Alto Research Center

2:20pm **AM+EM+MS+TF-ThA1 Additive Printing for Flexible Electronic Devices**, *A.C. Pierre,* ***Ana Claudia Arias***, University of California at Berkeley **INVITED**

The area of printed electronics has been focused on the use of new classes of semiconducting and conducting materials in two main applications, displays and photovoltaics. Both applications require materials long-term stability, long shelf life as well the need for patterning and deposition over large areas. Over the past 10 years significant progress in the performance of printable materials has been reported including highly efficient solar cells, light emitting diodes and thin film transistors with mobilities as high as 10 cm^2/Vs. The work is highly motivated by the potential for high through put, high volume, low cost manufacturing. While large area electronics continues to be a good application for printed flexible devices, wearable medical devices, which benefit from new form factors, represent a good shift in direction of research in the field. Wearable medical sensors have the potential to play an essential role in the reduction of health care costs as they encourage healthy living by providing individuals feedback on personal vital signs and enable the facile implementation of both in-hospital and in-home professional health monitoring. In printed flexible electronics however, there are no standards for materials set, device models and fabrication methods. This lack of standards slows down design of new systems and the success of the technology as a whole. In this talk, I will review the state of the art of devices produced by printing and introduce a blade coating method that yields highly homogeneous flexible thin films that are applied to LEDS, photodiodes and TFTs. The application of these devices as building blocks for flexible electronics systems will also be discussed.

3:00pm **AM+EM+MS+TF-ThA3 Digital Microassembly for High-performance Printed Electronics**, ***Eugene Chow***, *J.P. Lu, G.L. Whiting, D.K. Biegelsen, S. Raychaudhuri, A.R. Völkel, J. Veres, P. Maeda, I. Matei, S. Nelaturi, L.S. Crawford*, Palo Alto Research Center (PARC) **INVITED**

Digitally printing micro-scale pre-fabricated building blocks instead of simpler materials enables an alternative route to printed electronics and opens up fundamentally new manufacturing capabilities. However, existing printing technologies do not provide the required accuracy and orientation control to print such micro objects. We will describe a demonstration of the fundamental process steps of such an electronic chip printer based on electrographic manipulation and xerographic concepts.

4:00pm **AM+EM+MS+TF-ThA6 3D Printed Bionic Nanomaterials**, ***Michael McAlpine***, University of Minnesota **INVITED**

The ability to three-dimensionally interweave biology with nanomaterials could enable the creation of bionic devices possessing unique geometries, properties, and functionalities. The development of methods for interfacing high performance devices with biology could yield breakthroughs in regenerative medicine, smart prosthetics, and human-machine interfaces. Yet, most high quality inorganic materials: 1) are two dimensional, 2) are hard and brittle, and 3) require high crystallization temperatures for maximally efficient performance. These properties render the corresponding devices incompatible with biology, which is: 1) three dimensional, 2) soft, flexible, and stretchable, and 3) temperature sensitive. These dichotomies are solved by: 1) using 3D scanning and printing for hierarchical, interwoven, multiscale material and device architectures, 2) using nanotechnology as an enabling route for overcoming mechanical discrepancies while revealing new effects due to size scaling, and 3) separating the materials synthesis and 3D printed assembly steps to enable conformal integration of high quality materials with biology. The coupling of 3D printing, novel nanomaterial properties, and 'living' platforms may enable next-generation nano-bio interfaces and 3D printed bionic nanodevices.

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